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## High Power Factor Preregulator

#### FEATURES

- Complete 8-pin Power Factor Solution
- Reduced External Components
- RMS Line Voltage Compensation
- Precision Multiplier/Squarer/Divider
- Internal 75kHz Synchronizable
  Oscillator
- Average Current Mode PWM
  Control
- Overvoltage Protection Comparator
- High Current, Clamped Gate Driver

#### DESCRIPTION

The UC3853 provides simple, yet high performance active power factor correction. Using the same control technique as the UC1854, this 8-pin device exploits a simplified architecture and an internal oscillator to minimize external component count. The UC3853 incorporates a precision multiplier/squarer/divider circuit, voltage and current loop error amplifiers, and a precision voltage reference to implement average current mode control with RMS line voltage compensation. This control technique maintains constant loop gain with changes in input voltage, which minimizes input line current distortion over the worldwide input voltage range.

The internal 75kHz oscillator includes an external clock input, allowing synchronization to downstream converters. Additionally, the device features an overvoltage protection comparator, a clamped MOSFET gate driver which self-biases low during undervoltage lockout, and low startup and supply current.

These devices are available in 8-pin plastic and ceramic dual in-line (DIP) packages, and 8-lead small outline (SOIC) packages. The UC1853 is specified for operation from  $-55^{\circ}$ C to  $+125^{\circ}$ C, the UC2853 is specified for operation from  $-25^{\circ}$ C to  $+85^{\circ}$ C, and the UC3853 is specified for operation from 0°C to  $+70^{\circ}$ C.



#### **BLOCK DIAGRAM**

#### UC1853 UC2853 UC3853

#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (VCC)
Output Drive Current,
Continuous0.125A
Peak0.5A
Output Minimum Voltage
IAC Maximum Input Current
IMO Maximum Output Current
IMO Minimum Voltage
FB Maximum Input Voltage
VCOMP Maximum Voltage6.2V
COMP Sourcing Current
COMP Sinking Current 20mA
COMP Maximum Voltage7.2V
Storage Temperature
Junction Temperature
Lead Temperature (Soldering, 10 sec.)+300°C
All voltages with respect to GND. Currents are positive into,

negative out of the specified terminal. Consult Packaging Section of Databook for thermal limitations and considerations of packages.

#### **CONNECTION DIAGRAM**



#### ELECTRICAL CHARACTERISTICS

Unless otherwise stated, these parameters apply for TA =  $-55^{\circ}$ C to  $+125^{\circ}$ C for the UC1853;  $-25^{\circ}$ C to  $+85^{\circ}$ C for the 2853; and 0°C to  $+70^{\circ}$ C for the UC3853; VCC = 16V, VFB = 3V, IAC = 100\muA, VVCOMP = 3.75V, VICOMP = 3V, TA = TJ.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS					
Undervoltage Lockout Section										
VCC Turn-on Threshold	VVCOMP, VICOMP Open		11.5	13	V					
Hysteresis		1.5	1.8	2.1	V					
Supply Current Section										
IVcc Startup	Vcc = 8V, IAC = 100µA; Vvcomp, Vicomp Open		250	500	μA					
IVcc	$IAC = 0\mu A$ , VICOMP = 0V		10	15	mA					
Voltage Loop Error Amplifier Section										
Transconductance	$IOUT = \pm 20 \mu A 0-70C$	300	450	575	μmho					
	Temperature	135		640	μmho					
Input Voltage	0-70C	2.925	3	3.075	V					
	Temperature	2.9		3.1	V					
AVOL	VVCOMP = 1V - 4V	50	60		dB					
Output Sink Current	VFB = 3.2V, VVCOMP = 3.75V	20	50		μA					
Output Source Current	VFB = 2.8V, VVCOMP = 3.75V		-50	-20	μA					
Output Voltage High		5.5	6		V					
Output Voltage Low			0.6	0.9	V					
Current Loop Error Amplifier Section		-								
Offset Voltage		0		6	mV					
Voltage Gain	VICOMP = 1V - 4V		70		dB					
Sink Current	VIMO = 100mV, VICOMP = 3V	1			mA					
Source Current	VIMO = -0.1V, $VICOMP = 3V$		-150	-80	μA					
Output High	IICOMP = -50mA	6	6.8		V					
Output Low	ΙΙCOMP = 50μΑ		0.3	0.8	V					
PWM Modulator Gain	VICOMP = 2V - 3V (Note 1)		20		%/V					

(continued)

**ELECTRICAL CHARACTERISTICS** Unless otherwise stated, these parameters apply for  $TA = -55^{\circ}C$  to  $+125^{\circ}C$  for the UC1853;  $-25^{\circ}$ C to +85°C for the 2853; and 0°C to +70°C for the UC3853; VCC = 16V, VFB = 3V, IAC = 100 $\mu$ A, VVCOMP = 3.75V, VICOMP = 3V, TA = TJ.

PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS					
Multiplier Section										
Output Current – IAC Limited	VCC = 11V, VVCOMP = 6V	-230	-200	-170	μA					
Output Current – Zero	$IAC = 0\mu A$	-2	-0.2	2	μA					
Output Current – Power Limited	VCC = 12V, VVCOMP = 5.5V	-236	-178	-168	μA					
Output Current	VCC= 12V, VVCOMP = 2V		-22		μA					
	VCC= 12V, VVCOMP = 5V		-156		μA					
	VCC= 40V, VVCOMP = 2V		-2		μΑ					
	VCC= 40V, VVCOMP = 5V		-14		μA					
Multiplier Gain Constant	VCC= 12V, VVCOMP = 5.5V (Note 2)	-1.05	-0.9	-0.75	V <sup>-1</sup>					
Oscillator Section										
Oscillator Initial Frequency	TA = 25°C	67.5	75	82.5	kHz					
Oscillator Frequency	Line, Load, Temperature	56	75	94	kHz					
Synchronization Frequency Range				100	kHz					
Synchronization Pulse Amplitude	Pulse slew rate = 100V/µsec (Note 3)		2		V					
Output Driver Section										
Maximum Output Voltage	0mA load, VCC = 20V	12	15	17.5	V					
Output High	0mA load, VCC = 12V, ref. to VCC	-2.7	-1.7		V					
	-50mA load, VCC = 12V, ref. to VCC	-3	-2.2		V					
Output Low (Device Inactive)	Vcc = 0V, 20mA load (Sinking)		0.9	2.0	V					
Output Low (Device Active)	50mA load (Sinking)		0.5	1	V					
OUT Rise Time	1nF from OUT to GND		55	100	ns					
OUT Fall Time	1nF from OUT to GND		35	100	ns					
OUT Maximum Duty Cycle	VICOMP = 0V	88	93		%					
OVP Comparator Section										
Threshold Voltage	Volts Above EA Input V	90	150		mV					
Hysteresis			80		mV					

Note 1:

*PWM* modulator gain =  $\frac{\Delta DutyCycle}{\Delta V}$  $\Delta V$ ICOMP

Note 2:

$$Gain \ constant \ (K) = \frac{IAC \bullet (VCOMP - 1.5V)}{IMO \bullet VCC \bullet \frac{VCC}{64}}, \ VCC = 12V.$$

Note 3. Synchronization is accomplished with a falling edge of 2V magnitude and 100V/µsec slew rate.

### UC1853 UC2853 UC3853

#### **PIN DESCRIPTIONS**

**FB:** Voltage Amplifier Inverting Input, Overvoltage Comparator Input, Sync Input. This pin serves three functions. FB accepts a fraction of the power factor corrected output voltage through a voltage divider, and is nominally regulated to 3V. FB voltages 5% greater than nominal will trip the overvoltage comparator, and shut down the output stage until the output voltage drops 5%. The internal oscillator can be synchronized through FB by injecting a 2V clock signal though a capacitor. To prevent false tripping of the overvoltage comparator, the clock signal must have a fast falling edge, but a slow rising edge. See Application Note U-159 for more information.

**GND:** Ground. All voltages are measured with respect to GND. The VCC bypass capacitor should be connected to ground as close to the GND pin as possible.

**IAC:** AC Waveform Input. This input provides voltage waveform information to the multiplier. The current loop will try to produce a current waveform with the same shape as the IAC signal. IAC is a low impedance input, nominally at 2V, which accepts a current proportional to the input voltage. Connect a resistor from the rectified input line to IAC which will conduct 500mA at maximum line voltage.

**IMO:** Multiplier Output and Current Sense Inverting Input. The output of the multiplier and the inverting input of the current amplifier are connected together at IMO. Avoid bringing this input below –0.5V to prevent the internal protection diode from conducting. The multiplier output is a current, making this a summing node and allowing a differential current error amplifier configuration to reject ground noise. The input resistance at this node should be 3.9k to minimize input bias current induced offset voltage. See the Applications section for the recommended circuit configuration.

**OUT:** Gate Driver Output. OUT provides high current gate drive for the external power MOSFET. A 15V clamp pre-

vents excessive MOSFET gate-to-source voltage so that the UC3853 can be operated with VCC and high as 40V. A series gate resistor of at least 5 ohms should be used to minimize clamp voltage overshoot. In addition, a Schottky diode such as a 1N5818 connected between OUT and GND may be necessary to prevent parasitic substrate diode conduction.

**ICOMP:** Current Loop Error Amplifier Output. The current loop error amplifier is a conventional operational amplifier with a  $150\mu$ A current source class A output stage. Compensate the current loop by placing an impedance between ICOMP and IMO. This output can swing above the oscillator peak voltage, allowing zero duty cycle when necessary.

**VCC:** Input Supply Voltage. This pin serves two functions. It supplies power to the chip, and an input voltage level signal to the squarer circuit. When this input is connected to a DC voltage proportional to the AC input RMS voltage, the voltage loop gain is reduced by

64		
Vcc <sup>2</sup>	•	

This configuration maintains constant loop gain. The UC3853 input voltage range extends from 12V to 40V, allowing an AC supply voltage range in excess of 85VAC to 265VAC. Bypass VCC with at least a  $0.1\mu$ F ceramic capacitor to ensure proper operation. See the Applications section for the recommended circuit configuration.

**VCOMP:** Voltage Loop Error Amplifier Output. The voltage loop error amplifier is a transconductance type operational amplifier. A feedback impedance between VCOMP and FB for loop compensation must be avoided to maintain proper operation of the overvoltage protection comparator. Instead, compensate the voltage loop with an impedance between VCOMP and GND. When VCOMP is below 1.5V, the multiplier output current is zero.

#### **UC3853 TYPICAL APPLICATION**





Note: the application circuit shown is a 100W, 75KHz design. Additional application information can be found in Application Note U–159 and Design Note DN–78. V IEXAS NSTRUMENTS www.ti.com

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finis	h MSL Peak Temp <sup>(3)</sup>
UC2853D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2853DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2853DTR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2853DTRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2853N	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC2853NG4	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC3853D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3853DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3853DTR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3853DTRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3853N	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC3853NG4	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2853DTR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
UC3853DTR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1



## PACKAGE MATERIALS INFORMATION

29-Jul-2008



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2853DTR	SOIC	D	8	2500	346.0	346.0	29.0
UC3853DTR	SOIC	D	8	2500	346.0	346.0	29.0

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